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To the Honorable Assistant Commissioner for Patents. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Hee-jin LEE

Additional name(s) of conveying party(ies) attached?
 yes no

2. Name and address of receiving party(ies)?

Name:
SAMSUNG ELECTRONICS CO., LTD.
Internal Address:
416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic
of Korea
Street Address:
Same as above

City State Zip

Additional name(s) & address(es) attached?
 yes no

3. Nature of Conveyance:

Assignment Merger
 Security Agreement Change of Name
 Other

Execution Date: June 23, 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:
June 23, 2000

A. Patent Application No.(s)

B. Patent No(s).

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

SUGHRUE, MIOW, ZINN, MACPEAK & SEAS
2100 Pennsylvania Avenue, N.W.
Suite 800
Washington, D.C. 20037-3202

6. Total number of applications and patents involved:
One (1)

7. Total Fee (37 CFR 3.41): \$ 40.00
 Enclosed. Please charge any underpayment in
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9. Statement and Signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Paul E. Feil Reg. 33102
Name Darhyl Mexic Reg. No. 23,063

June 26, 2000
Date

TOTAL NUMBER OF PAGES INCLUDING COVER SHEET, ATTACHMENTS AND DOCUMENT: 2

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PATENT
REEL: 010924 FRAME: 0674

ASSIGNMENT

Whereas, I/We, Hee-jin Lee of 506-901 Jugong 5-danji Apt.,
187 Kaepo 3-dong, Kangnam-gu, Seoul, Rep. of Korea

hereinafter called assignor(s), have invented certain improvements in
METHOD FOR MATCHING UPPER PROTOCOL LAYER TO HIGH SPEED SERIAL BUS
and executed an application for Letters Patent of the United States of America therefor on
23 June 2000; and

Whereas, SAMSUNG ELECTRONICS CO., LTD. of 416, Maetan-dong, Paldal-gu,
Suwon-city, Kyungki-do, Republic of Korea (assignee), desires to acquire the entire right, title
and interest in the application and invention, and to any United States patents to be obtained
therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We the above-named assignor(s), hereby sell, assign and transfer to the above named
assignee, its successors and assigns, the entire right, title and interest in the application and
the invention disclosed therein for the United States of America, including the right to claim
priority under 35 U.S.C. & 119, and I/we request the Commissioner of Patents to issue any
Letters Patent granted upon the invention set forth in the application to the assignee, its
successors and assigns; and I/we will execute without further consideration all papers deemed
necessary by the assignee in connection with the United States application when called upon
to do so by the assignee.

I/We hereby authorize and request my attorneys SUGHRUE, MION, ZINN,
MACPEAK & SEAS of 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3202 to
insert here in parentheses (Application number _____, filed _____)
the filing date and application number of said application when known.

Date: 23 June 2000

s/ LEE, HEE-JIN
Hee-jin Lee

Date: _____

s/ _____

Date: _____

s/ _____

Date: _____

s/ _____

Date: _____

s/ _____

(Legalization not required for recording but is prima facie evidence of execution under 35
U.S.C. & 261)

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